

**Features**

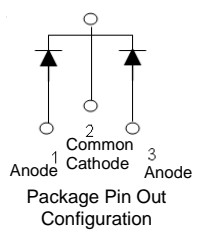
- Low Forward Voltage Drop
- Low Leakage Current
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 175°C Operating Junction Temperature
- **Lead Free Finish, RoHS Compliant (Note 1)**
- **Also Available in Green Molding Compound (Note 2)**

**Mechanical Data**

- Case: D<sup>2</sup>Pak
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 1.6 grams (approximate)



Top View

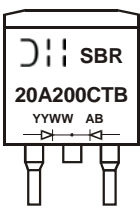


**Ordering Information** (Notes 2 & 3)

Part Number	Case	Packaging
SBR20A200CTB	D <sup>2</sup> Pak	50 pieces/tube
SBR20A200CTB-G	D <sup>2</sup> Pak	50 pieces/tube
SBR20A200CTB-13	D <sup>2</sup> Pak	800/Tape & Reel
SBR20A200CTB-13-G	D <sup>2</sup> Pak	800/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes  
 2. For Green Molding Compound version part numbers, add "-G" suffix to part number above. Examples: SBR20A200CTB-G.  
 3. For packaging details, go to our website at <http://www.diodes.com>.

**Marking Information**



SBR20A200CTB = Product Type Marking Code  
 AB = Foundry and Assembly Code  
 YYWW = Date Code Marking  
 YY = Last two digits of year (ex: 07 = 2007)  
 WW = Week (01 - 53)

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### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	200	V
Working Peak Reverse Voltage	V <sub>RWM</sub>		
DC Blocking Voltage	V <sub>RM</sub>		
Average Rectified Output Current @ T <sub>C</sub> = 150°C	I <sub>O</sub>	20	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	180	A

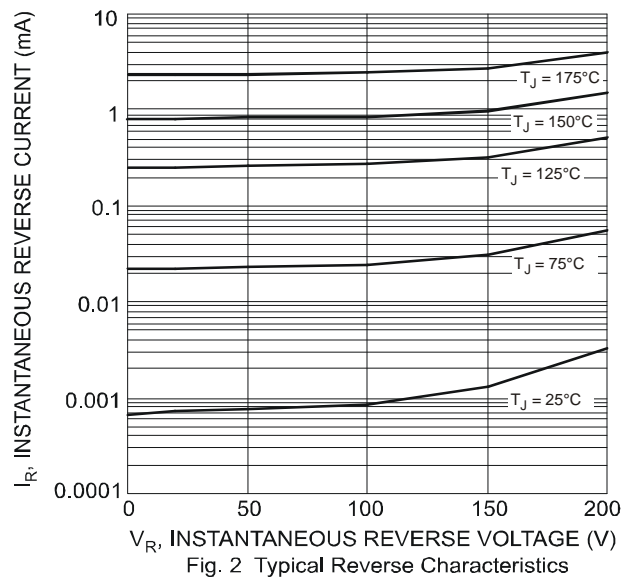
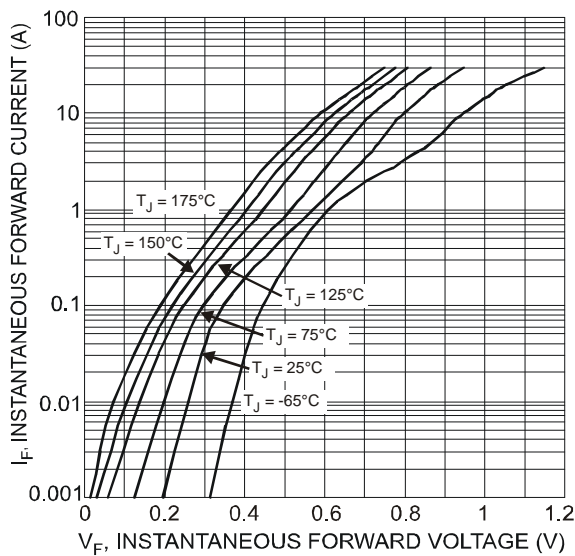
### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance (per leg)			
Thermal Resistance Junction to Case (Note 4)	R <sub>θJC</sub>	4	°C/W
Thermal Resistance, Junction to Ambient (Note 4)	R <sub>θJA</sub>	43	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +175	°C

### Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V <sub>F</sub>	-	-	0.86	V	I <sub>F</sub> = 10A, T <sub>J</sub> = 25°C
			-	0.96		I <sub>F</sub> = 20A, T <sub>J</sub> = 25°C
			0.66	0.72		I <sub>F</sub> = 10A, T <sub>J</sub> = 125°C
Leakage Current (Note 5)	I <sub>R</sub>	-	0.003	0.1	mA	V <sub>R</sub> = 200V, T <sub>J</sub> = 25°C
			0.51	10		V <sub>R</sub> = 200V, T <sub>J</sub> = 125°C
Reverse Recovery Time	t <sub>rr</sub>	-	24	30	ns	I <sub>F</sub> = 0.5A, I <sub>R</sub> = 1A, I <sub>RR</sub> = 0.25A
		-	20	25		I <sub>F</sub> = 1A, V <sub>R</sub> = 30V, di/dt = 100A/μs, T <sub>J</sub> = 25°C

Notes: 4. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>  
5. Short duration pulse test used to minimize self-heating effect.



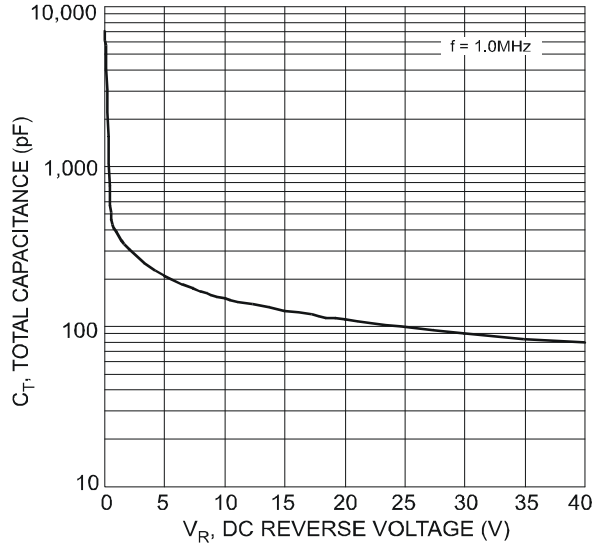


Fig. 3 Total Capacitance vs. Reverse Voltage

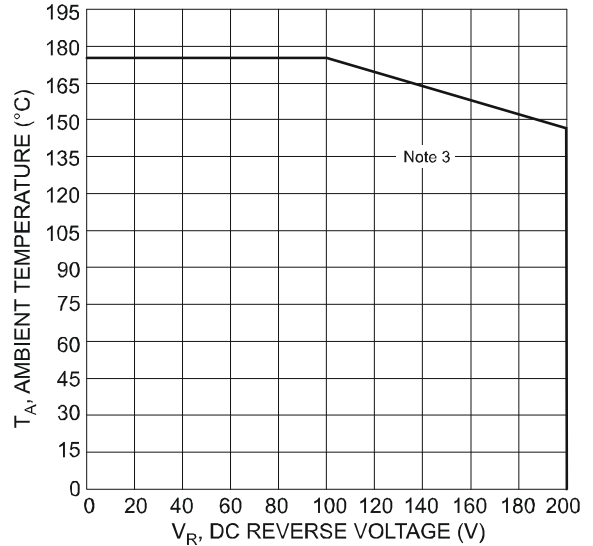
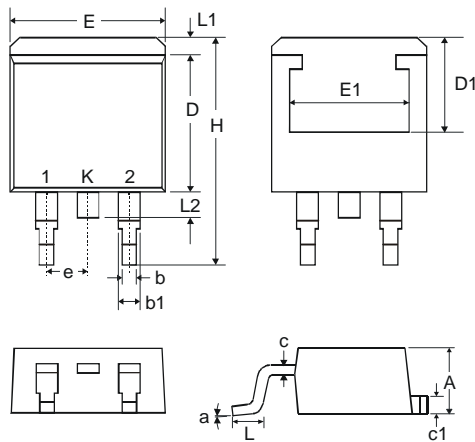


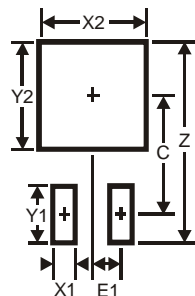
Fig. 4 Operating Temperature Derating

**Package Outline Dimensions**



D <sup>2</sup> PAK		
Dim	Min	Max
A	4.07	4.82
b	0.51	0.99
b1	1.15	1.77
c	0.356	0.58
c1	1.143	1.65
D	8.39	9.65
D1	6.55	—
E	9.66	10.66
E1	6.23	—
e	2.54 Typ	
H	14.61	15.87
L	1.78	2.79
L1	—	1.67
L2	—	1.77
a	0°	8°
All Dimensions in mm		

**Suggested Pad Layout**



Dimensions	Value (in mm)
Z	16.9
X1	1.1
X2	10.8
Y1	3.5
Y2	11.4
C	9.5
E1	2.5

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SBR20A200CTB  
Document number: DS31076 Rev. 6 - 2

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September 2010  
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